

新品承认书

NEW PRODUCT APPROVED

客户名称 (CUSTOMERS) _____

客户 P/N (CUSTOMER P/N) _____

升谱 P/N (SUNPU P/N) _____ NEPS-2011ASR-G _____

产品说明 (DESCRIPTION) 0.2 英寸单八 共阳 高亮红色显示

送样日期 (SAMPLE DATE) _____

| | | | | | | | |
|-------------------------------|-------------------------------------|---------------------------|--------------------------|---------------------|--------------------------|---------------------|--------------------------|
| 产品说明书 Specification | <input checked="" type="checkbox"/> | 检验报告 INSPECTION | <input type="checkbox"/> | 样品 SAMPLE | <input type="checkbox"/> | 其它 OTHERS | <input type="checkbox"/> |
| 核准 (APPROVED BY) | 审核 (CHECKED BY) | 校对 (PROOFREAD BY) | 制作 (PREPARED BY) | | | | |

更改履历表

| 版本 Version | 日期 date | 描述 | 编制 Maker |
|------------|---------|----|----------|
| | | | |
| | | | |
| | | | |

客户判定结果 (CUSTOMER VERDICT)

承认(OK)

不承认(NG)

承认签名(APPROVED BY):

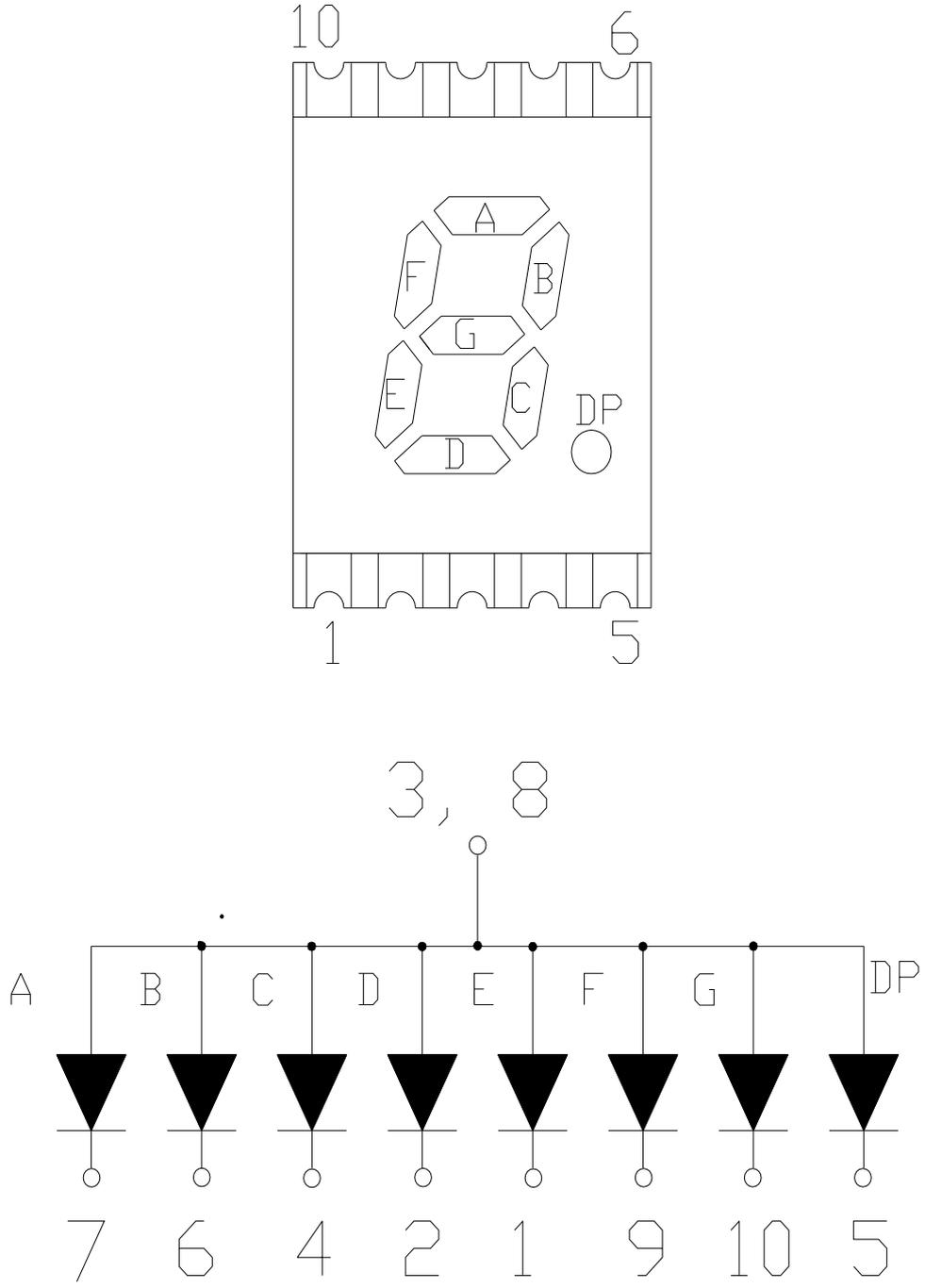
承认时间(APPROVED DATE):

改善意见(IMPROVED ADVICE):

说明: 为了能更好的服务客户, 请及时回传以上信息

REMARK: FOR OFFERING THE BEST SERVICE TO CUSTOMER, PLEASE FAX THE DATA TO FACTORY

4. 产品线路图 INTERNAL CIRCUIT DIAGRAM

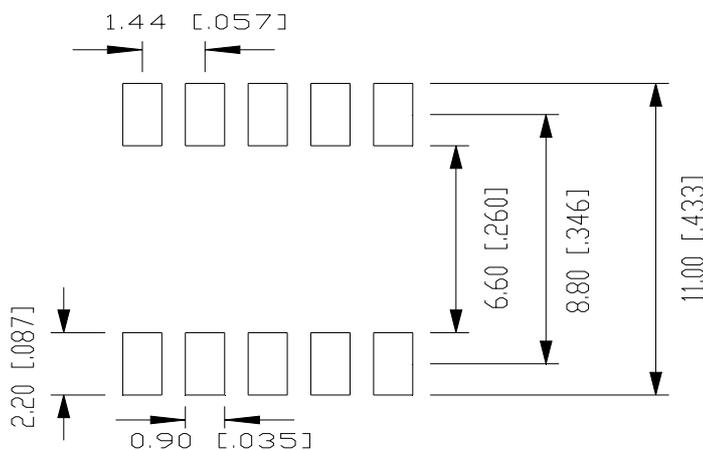


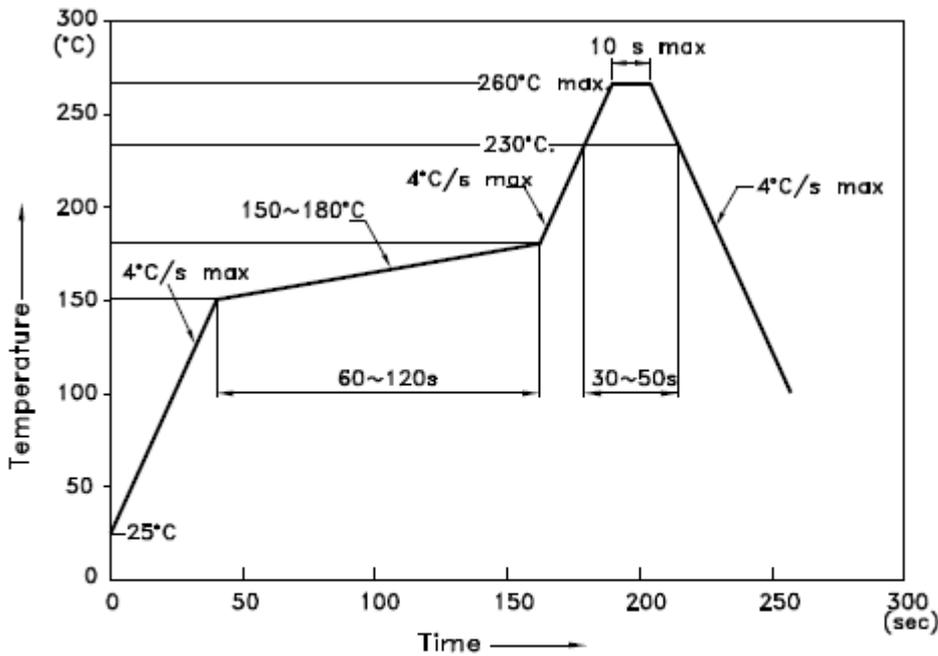
5、产品最大绝对参数值 (Ta: 25°C) ABSOLUTE MAXIMUM RATINGS AT Ta=25°C:

| 参数 (PARAMETER) | 最大值 Max. | 单位 UNIT |
|--|-------------------------|--------------|
| 每段功耗 Power Dissipation Per Segment | 52 | mW |
| 每段峰值电流 Peak Forward Current Per Segment (1/10duty cycle 0.1ms pulse width) | 100 | mA |
| 每段平均正向电流 Average Forward Current Per Segment | 20 | mA |
| 从室温线性减少 Derating Linear From 25°C Per Segment | 0.33 | mA/°C |
| 每段反向电压 Reverse Voltage Per Segment | 5 | V |
| 工作条件温度 Operating Temperature Range | -40°C to + 105°C | |
| 储存温度 Storage Temperature Range | -40°C to + 105°C | |
| 距离胶体 1.6mm 焊接, 温度 260°C , 焊接时间最多 3 秒 Lead Soldering Temperature 260°C at 1.6mm From Body for 3 seconds | | |

6、产品光电参数值 (Ta: 25°C) ELECTRICAL/OPTICAL CHARACTERISTICS AT Ta=25°C:

| 参数 PARAMETER | 符号 SYMBOL | MIN. | TYP. | MAX. | UNIT | 测试条件 Test condition |
|-------------------------------------|-----------------|------|------------|------------|---------------------------|------------------------------|
| 每段亮度 Luminous Intensity Per Segment | I_v | — | 9 | — | mcd | $I_F=10mA$ |
| 主波长 Dominant Wavelength | λ_d | — | 620 | — | nm | $I_F=20mA$ |
| 光谱半宽度 Spectral Line Half-Width | $\Delta\lambda$ | — | 30 | — | nm | $I_F=20mA$ |
| 每颗正向电压 Forward Voltage Per Dice | V_F | — | 2.0 | 2.6 | V | $I_F=20mA$ |
| 每颗反向电流 Reverse Current Per Dice | I_R | — | — | 50 | μA | $V_R=5V$ |

7、推荐使用的焊盘尺寸 Recommended Soldering Pattern:

8、推荐的 SMT 焊接曲线 Recommended SMT condition:



NOTES:

1. We recommend the reflow temperature $245^{\circ}\text{C}(\pm 5^{\circ}\text{C})$. The maximum soldering temperature should be limited to 260°C .
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.